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N-Channel PowerTrench[®] MOSFET 40 V, 76 A, 3.1 m Ω

Features

- Max r_{DS(on)} = 3.1 mΩ at V_{GS} = 10 V, I_D = 22 A
- Max r_{DS(on)} = 4.3 mΩ at V_{GS} = 4.5 V, I_D = 19 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

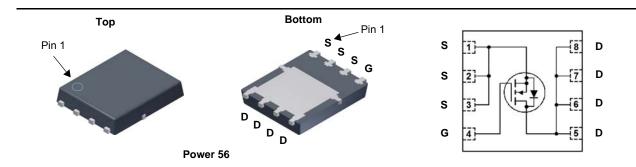


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- OringFET / Load Switching
- Synchronous rectification
- DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter				Ratings	Units	
V _{DS}	Drain to Source V	oltage			40	V	
V _{GS}	Gate to Source Vo	oltage			±20	V	
	Drain Current	-Continuous	T _C = 25 °C		76		
I _D		-Continuous	T _A = 25 °C	(Note 1a)	22	Α	
		-Pulsed		(Note 4)	250		
E _{AS}	Single Pulse Avala	anche Energy		(Note 3)	216	mJ	
P _D	Power Dissipation		T _C = 25 °C		69	W	
	Power Dissipation		T _A = 25 °C	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range				-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C 1.11
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 50	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8333L	FDMS8333L	Power 56	13 "	12 mm	3000 units

December 2014

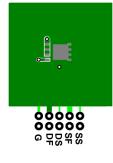
FDMS8333L
N-Channel
PowerTrench
[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	40			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		22		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA	
On Chara	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.8	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
		V _{GS} = 10 V, I _D = 22 A		2.4	3.1		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 19 A		3.3	4.3	mΩ	
		V _{GS} = 10 V, I _D = 22 A, T _J = 125 °C		3.6	4.7		
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 22 A		120		S	
C _{iss}	Characteristics Input Capacitance	V - 20 V V - 0 V		3245	4545	pF	
		V _{DS} = 20 V, V _{GS} = 0 V,					
C _{oss}	Output Capacitance	f = 1 MHz		840	1175	pF	
C _{rss}	Reverse Transfer Capacitance		0.4	32	55	pF	
R _g	Gate Resistance		0.1	0.7	2.1	Ω	
	g Characteristics			44	05		
t _{d(on)}	Turn-On Delay Time			14	25	ns	
t _r	Rise Time	V _{DD} = 20 V, I _D = 22 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		4.7	10	ns	
t _{d(off)}	Turn-Off Delay Time Fall Time	$v_{GS} = 10 v, r_{GEN} = 0.22$		33	53 10	ns	
t _f		$\gamma = 0 \gamma t_0 10 \gamma t_0$		4.2		ns	
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		46	64	nC nC	
Q _g	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 20 \text{ V},$ $I_D = 22 \text{ A}$		22	31	-	
Q _{gs}	Gate to Source Charge Gate to Drain "Miller" Charge			8.8 5.5		nC nC	
Q _{gd}	Gale to Drain Miller Charge			5.5		nc	
Drain-So	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 1.9 A$ (Note 2)		0.7	1.2	v	
V SD	Brain Biodo i omara Voltago	$V_{GS} = 0 V, I_S = 22 A$ (Note 2)		0.8	1.3	v	

t_{rr} Q_{rr}

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

 I_F = 22 A, di/dt = 100 A/µs



Reverse Recovery Time

Reverse Recovery Charge

a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

38

20

61

32

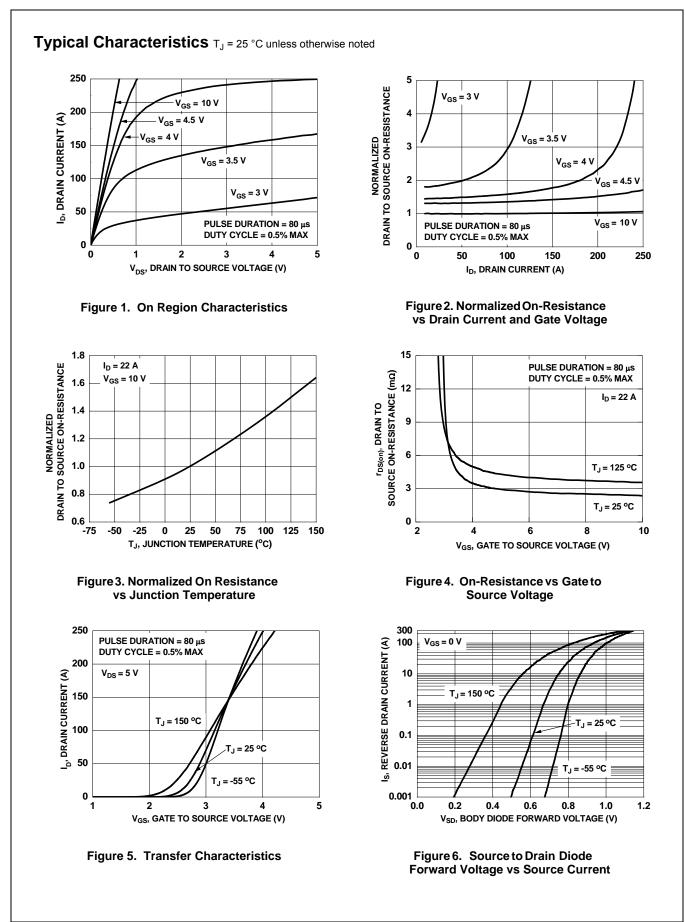
ns

nC

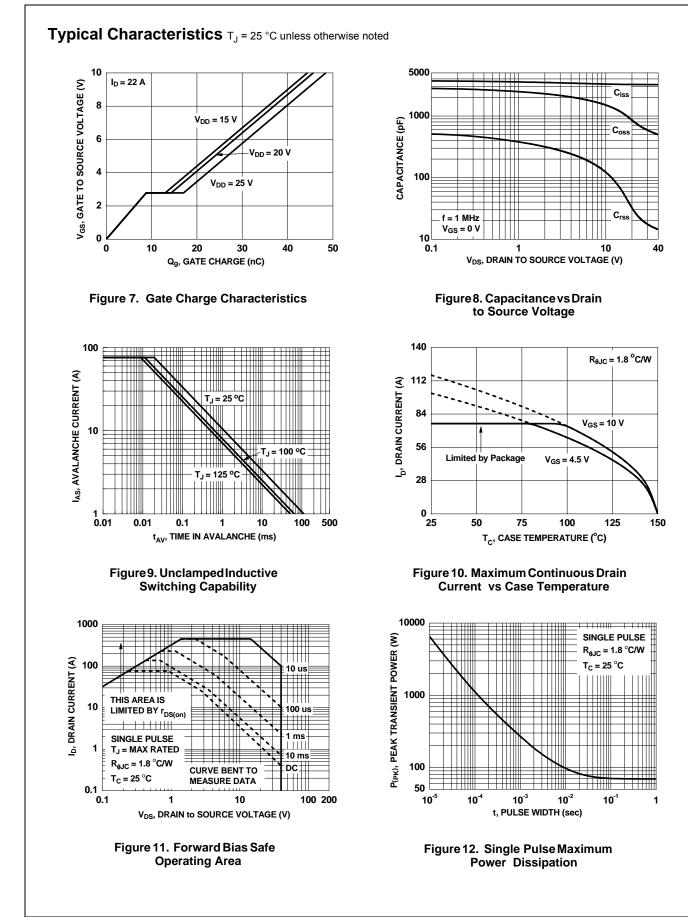
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

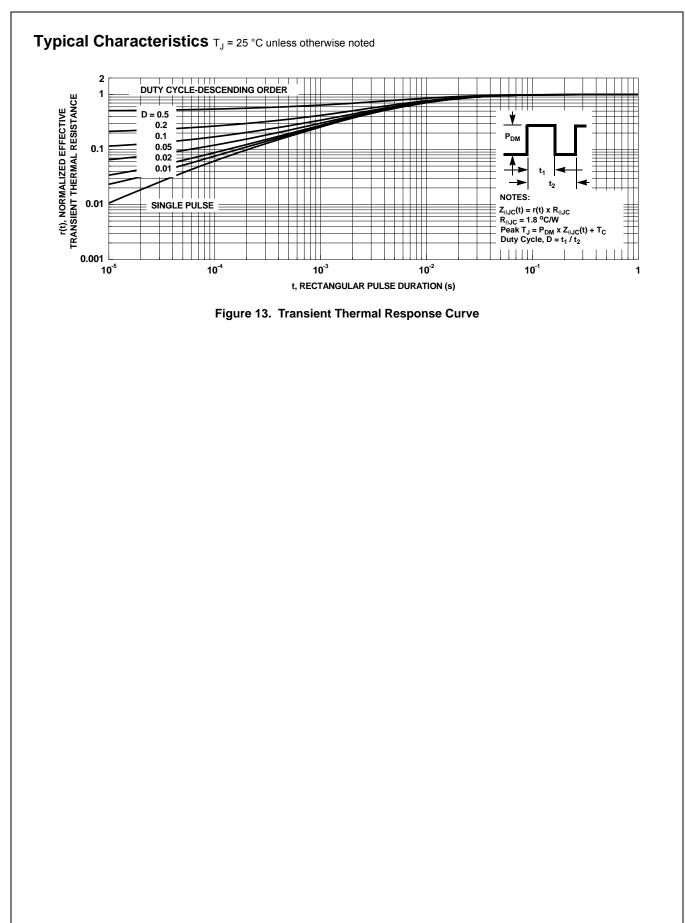
3. E_{AS} of 216 mJ is based on starting T_J = 25 °C; N-ch: L = 3 mH, I_{AS} = 12 A, V_{DD} = 40 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 38 A.

4. Pulsed Id limited by junction temperature, td<=100 μS, please refer to SOA curve for more details.









FDMS8333L N-Channel PowerTrench[®] MOSFET



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